

3A, 200V - 1000V Standard Surface Mount Rectifier

FEATURES

- AEC-Q101 qualified
- Glass passivated chip junction
- High surge current capability
- Ideal for automated placement
- Wettable flank
- Moisture sensitivity level: level 1, per J-STD-020
- RoHS Compliant
- Halogen-free according to IEC 61249-2-21

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- DC to DC converter
- Automotive application
- Car lighting
- Snubber

MECHANICAL DATA

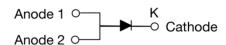
- Case: TO-277A (SMPC4.6U)
- Molding compound meets UL 94V-0 flammability rating
- Terminal: Matte tin plated leads, solderable per J-STD-002
- Meet JESD 201 class 2 whisker test
- Polarity: Indicated by cathode band
- Weight: 0.107g (approximately)

KEY PARAMETERS					
PARAMETER VALUE UNI					
I _F	3	Α			
V_{RRM}	200 - 1000	V			
I _{FSM}	100	Α			
T _{J MAX}	150	°C			
Package	TO-277A (SMPC4.6U)				
Configuration	Single die				





TO-277A (SMPC4.6U)



ABSOLUTE MAXIMUM RATINGS (T _A = 25°C unless otherwise noted)								
PARAMETER		SYMBOL	TUAS 3DH	TUAS 3GH	TUAS 3JH	TUAS 3KH	TUAS 3MH	UNIT
Marking code on the dev	Marking code on the device		AS3D	AS3G	AS3J	AS3K	AS3M	
Repetitive peak reverse voltage		V_{RRM}	200	400	600	800	1000	V
Reverse voltage, total rms value		V _{R(RMS)}	140	280	420	560	700	V
Forward current		I _F	3				Α	
Surge peak forward current single half sine-					100			A
wave superimposed on rated load $t = 1.0 ms$		I _{FSM}	260					
Junction temperature		TJ	-55 to +150				°C	
Storage temperature		T _{STG}	-55 to +150				°C	

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THERMAL PERFORMANCE					
PARAMETER	SYMBOL	TYP	UNIT		
Junction-to-lead thermal resistance	$R_{\Theta JL}$	5.4	°C/W		
Junction-to-ambient thermal resistance	R _{OJA}	46	°C/W		
Junction-to-case thermal resistance	R _{eJC}	8.9	°C/W		

Thermal Performance Note: Units mounted on PCB (16mm x 16mm Cu pad test board)

ELECTRICAL SPECIFICATIONS (T _A = 25°C unless otherwise noted)							
PARAMETER		CONDITIONS	SYMBOL	TYP	MAX	UNIT	
- (1)		$I_F = 1.5A, T_J = 25^{\circ}C$	V _F	0.88	-	V	
		$I_F = 3.0A, T_J = 25^{\circ}C$		0.94	1.10	V	
Forward voltage	Forward voltage ⁽¹⁾			0.76	-	V	
				0.83	-	V	
Reverse current @ rated V _R ⁽²⁾		T _J = 25°C	I _R	-	5	μΑ	
		T _J = 125°C		11	-	μΑ	
TUAS3DH TUAS3GH Junction capacitance TUAS3JH		1MHz, V _R = 4.0V	C _J	27	-	pF	
·	TUAS3KH TUAS3MH			24	-		

Notes:

- 1. Pulse test with PW = 0.3ms
- 2. Pulse test with PW = 30ms

ORDERING INFORMATION					
ORDERING CODE ⁽¹⁾	PACKAGE	PACKING			
TUAS3xH	TO-277A (SMPC4.6U)	6,000 / Tape & Reel			

Notes:

1. "x" define voltage from 200V(TUAS3DH) to 1000V(TUAS3MH)



CHARACTERISTICS CURVES

 $(T_A = 25^{\circ}C \text{ unless otherwise noted})$

Fig.1 Forward Current Derating Curve

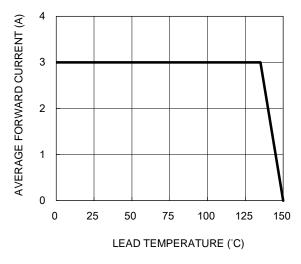


Fig.3 Typical Reverse Characteristics

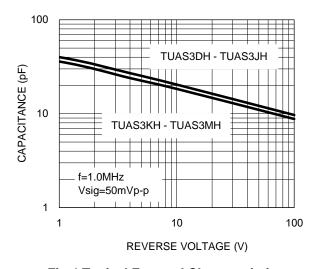
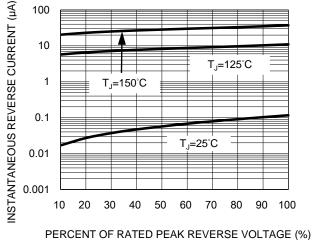
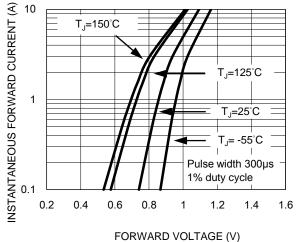


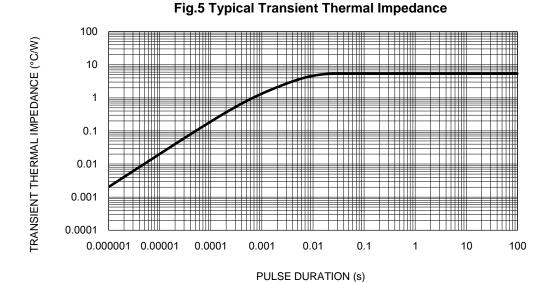
Fig.2 Typical Junction Capacitance

Fig.4 Typical Forward Characteristics



EVERSE VOLTAGE (%)

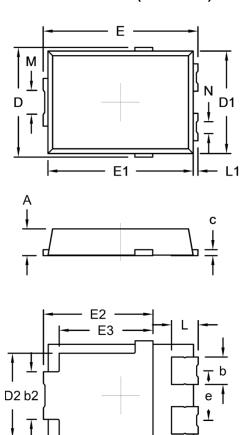






PACKAGE OUTLINE DIMENSIONS

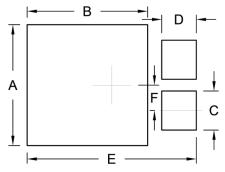
TO-277A (SMPC4.6U)



DIM.	Unit	(mm)	Unit (inch)		
DIIVI.	Min.	Max.	Min.	Max.	
Α	1.00	1.20	0.039	0.047	
b	1.05	1.35	0.041	0.053	
b2	1.90	2.20	0.075	0.087	
b4	0.75 (NOM.)	0.030	(NOM.)	
С	0.15	0.40	0.006	0.016	
D	4.45	4.75	0.175	0.187	
D1	4.25	4.35	0.167	0.171	
D2	3.40	3.70	0.134	0.146	
E	6.35	6.65	0.250	0.262	
E1	6.05	6.15	0.238	0.242	
E2	4.40	4.80	0.173	0.189	
E3	3.94 (NOM.)		0.155 (NOM.)		
е	2.08 (NOM.)	0.082 (NOM.)		
L	0.94	1.24	0.037	0.049	
L1	0.05	0.35	0.002	0.014	
М	0.65	1.15	0.026	0.045	
N	0.25	0.75	0.010	0.030	

Package body size D1 and E1 do not include mold flash Mold flash shall not exceed 0.1mm per side

SUGGESTED PAD LAYOUT

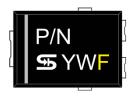


b4

Symbol	Unit (mm)	Unit (inch)
Α	4.95	0.195
В	4.95	0.195
С	1.60	0.063
D	1.42	0.056
E	6.95	0.274
F	1.04	0.041

This recommended land pattern is for reference purposes only. Please consult your manufacturing group to ensure your PCB design guidelines are met.

MARKING DIAGRAM



P/N = Marking Code YW = Date Code F = Factory Code



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